





SURFACE MOUNT FAST SWITCHING DIODE

Features

- Fast Switching Speed
- Ultra-Small Surface Mount Package
- For General Purpose Switching Applications
- High Conductance
- Lead, Halogen and Antimony Free, RoHS Compliant "Green" Device (Notes 3 and 4)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOD-323
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Leads: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Polarity: Cathode Band
- Marking Information: See Page 3
- Ordering Information: See Page 3
- Weight: 0.004 grams (approximate)

SOD-323



TOP VIEW

Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage		V_{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	75	V
RMS Reverse Voltage		V _{R(RMS)}	53	V
Forward Continuous Current		I _{FM}	500	mA
Average Rectified Output Current		lo	250	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0s	I _{FSM}	4.0 2.0	А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 2)	P _D	200	mW
Thermal Resistance Junction to Ambient Air (Note 2)	$R_{ hetaJA}$	625	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

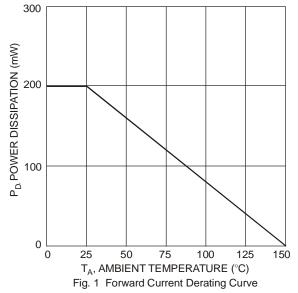
Electrical Characteristics @T_A = 25°C unless otherwise specified

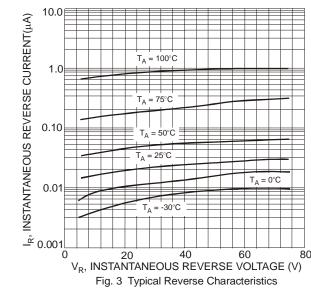
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 1)	$V_{(BR)R}$	75	_	V	$I_R = 2.5 \mu A$
		0.62	0.72	V	$I_F = 5.0 \text{mA}$
Forward Voltage	\/·	_	0.855		$I_F = 10 \text{mA}$
Forward Vollage	V _{FM}	_	1.0		I _F = 100mA
		_	1.25		I _F = 150mA
			2.5	μΑ	$V_R = 75V$
Peak Reverse Current (Note 1)	1		50	μΑ	V _R = 75V, T _J = 150°C
reak reverse Current (Note 1)	I _{RM}	_	30	μΑ	V _R = 25V, T _J = 150°C
			25	nA	$V_R = 20V$
Total Capacitance	Ст	_	4.0	pF	$V_R = 0, f = 1.0MHz$
Reverse Recovery Time	t _{rr}	_	4.0	ns	$I_F = I_R = 10 \text{mA},$
Reverse Recovery Time					$I_{rr} = 0.1 \times I_{R}, R_{L} = 100\Omega$

Notes:

- 1. Short duration pulse test used to minimize self-heating.
- Part mounted on FR-4 PC board with minimum recommended pad layouts, which can be found on our website at http://www/diodes.com/datasheets/ap02001.pdf.
- 3. No purposefully added lead. Halogen and Antimony Free.
- 4. Product manufactured with Data Čode V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb₂O₃ Fire Retardants.







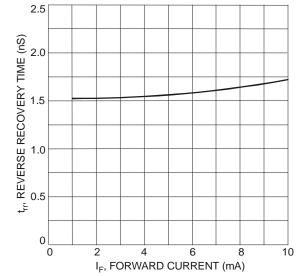
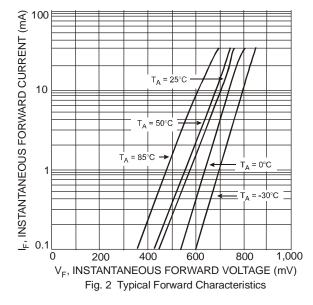
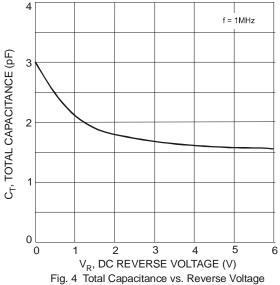


Fig. 5 Reverse Recovery Time vs. Forward Current







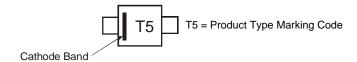
Ordering Information (Note 5)

Part Number	Case	Packaging
1N4448WS-7-F	SOD-323	3000/Tape & Reel

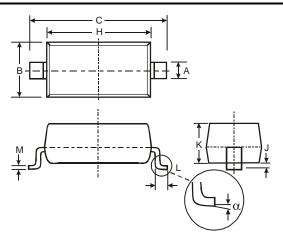
Notes:

5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information

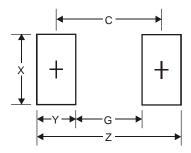


Package Outline Dimensions



SOD-323				
Dim	Min	Max		
Α	0.25	0.35		
В	1.20	1.40		
C	2.30	2.70		
Ξ	1.60	1.80		
7	0.00	0.10		
K	1.0	1.1		
٦	0.20	0.40		
М	0.10	0.15		
α	0°	8°		
All Dimensions in mm				

Suggested Pad Layout



Dimensions	Value (in mm)
Z	3.75
G	1.05
х	0.65
Y	1.35
С	2.40

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